

G3VM-61AY1/DY1

MOS FET Relays

Compact, General-purpose, Analog switching MOS FET Relays, with Dielectric Strength of 5 kVAC between I/O Using Optical Isolation.

- Switches minute analog signals.
- Continuous load current of 500 mA.

RoHS compliant

Application Examples

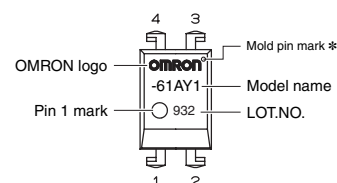
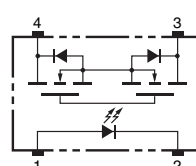
- Electrical power unit
- Test & Measurement equipment
- Security equipment
- Industrial equipment



NEW

Note: The actual product is marked differently from the image shown here.

Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

* The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

List of Models

Package type	Contact form	Terminals	Load voltage (peak value) *	Model	Minimum package quantity	
					Number per tube	Number per tape and reel
DIP4	1a (SPST-NO)	PCB Terminals	60 V	G3VM-61AY1	100	-
		Surface-mounting Terminals		G3VM-61DY1		
				G3VM-61DY1(TR05)	-	500

* The AC peak and DC value are given for the load voltage.

Absolute Maximum Ratings (Ta = 25°C)

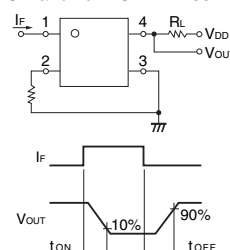
Item		Symbol	Rating	Unit	Measurement conditions
Input	LED forward current	IF	30	mA	
	Repetitive peak LED forward current	IFP	1	A	100 μ s pulses, 100 pps
	LED forward current reduction rate	$\Delta I_F / ^\circ C$	-0.3	mA/ $^\circ C$	Ta $\geq 25^\circ C$
	LED reverse voltage	VR	5	V	
	Connection temperature	TJ	125	$^\circ C$	
Output	Load voltage (AC peak/DC)	VOFF	60	V	
	Continuous load current (AC peak/DC)	IO	500	mA	
	ON current reduction rate	$\Delta I_O / ^\circ C$	-5	mA/ $^\circ C$	Ta $\geq 25^\circ C$
	Pulse ON current	IOP	1.5	A	t = 100 ms, Duty = 1/10
	Connection temperature	TJ	125	$^\circ C$	
Dielectric strength between I/O (See note 1.)		VI-O	5000	Vrms	AC for 1 min
Ambient operating temperature		Ta	-40 to +85	$^\circ C$	With no icing or condensation
Ambient storage temperature		Tstg	-55 to +125	$^\circ C$	With no icing or condensation
Soldering temperature		-	260	$^\circ C$	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

Electrical Characteristics (Ta = 25°C)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	LED forward voltage	VF	1.1	1.27	1.4	V	IF = 10 mA
	Reverse current	IR	-	-	10	μA	VR = 5 V
	Capacity between terminals	CT	-	50	-	pF	V = 0, f = 1 MHz
	Trigger LED forward current	IFT	-	0.6	3	mA	IO = 500 mA
Output	Maximum resistance with output ON	RON	-	0.6	2	Ω	IF = 5 mA, IO = 500 mA
	Current leakage when the relay is open	ILEAK	-	-	1000	nA	VOFF = 60 V
	Capacity between terminals	COFF	-	130	-	pF	V = 0, f = 1 MHz
	Capacity between I/O terminals	CI-O	-	0.8	-	pF	f = 1 MHz, Vs = 0 V
Insulation resistance between I/O terminals		RI-O	1000	-	-	M Ω	VI-O = 500 VDC, RoH $\leq 60\%$
Turn-ON time		TON	-	1	3	ms	IF = 5 mA, RL = 200 Ω , VDD = 20 V (See note 2.)
Turn-OFF time		TOFF	-	0.2	1	ms	

Note: 2. Turn-ON and Turn-OFF Times



Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

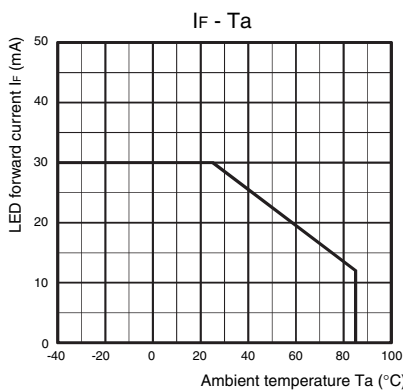
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V_{DD}	-	-	48	V
Operating LED forward current	I_F	5	7.5	25	mA
Continuous load current (AC peak/DC)	I_O	-	-	500	mA
Ambient operating temperature	T_a	-20	-	65	°C

Spacing and Insulation

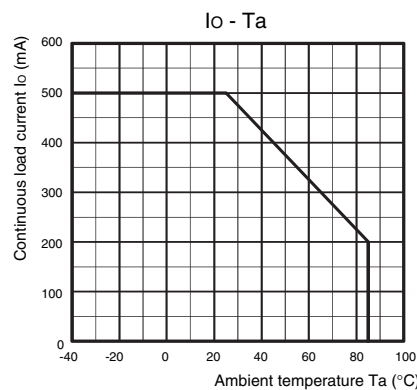
Item	Minimum	Unit
Creepage distances	7.0	mm
Clearance distances	7.0	
Internal isolation thickness	0.4	

Engineering Data

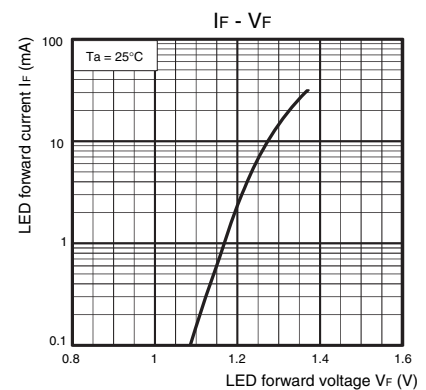
LED forward current vs. Ambient temperature



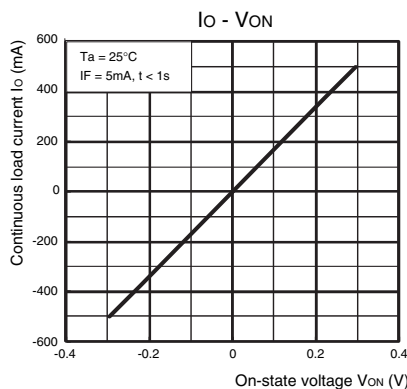
Continuous load current vs. Ambient temperature



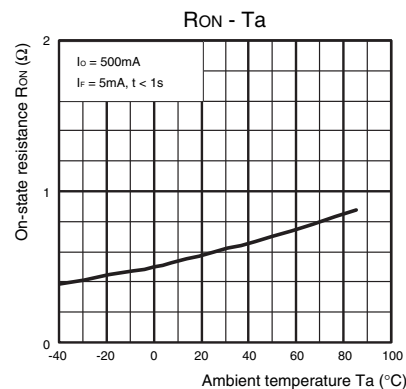
LED forward current vs. LED forward voltage



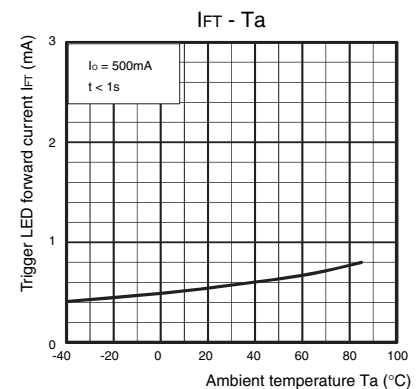
Continuous load current vs. On-state voltage



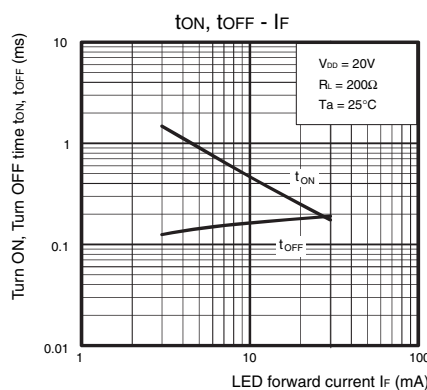
On-state resistance vs. Ambient temperature



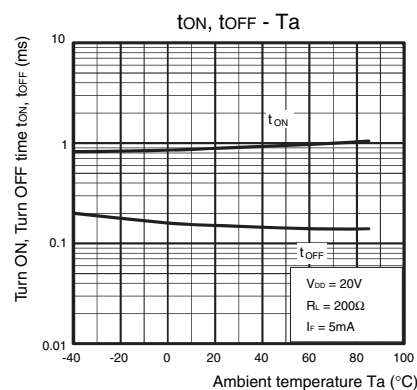
Trigger LED forward current vs. Ambient temperature



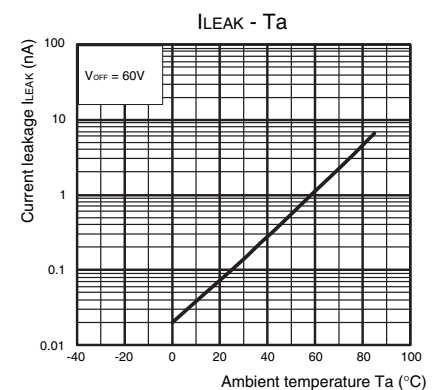
Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Ambient temperature

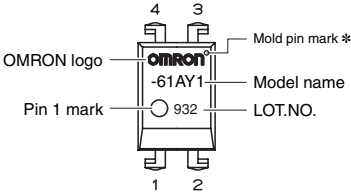


Safety Precautions

- Refer to "Common Precautions" for all G3VM models.

■ Appearance

DIP (Dual Inline Package) DIP4

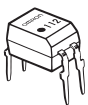


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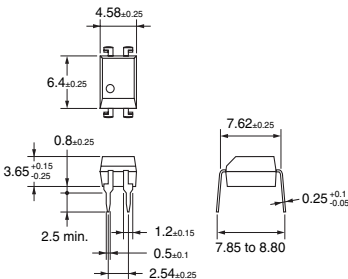
■ Dimensions

(Unit:mm)



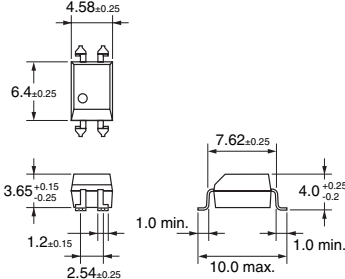
PCB Terminals

Weight: 0.25 g

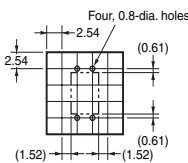


Surface-mounting Terminals

Weight: 0.25 g

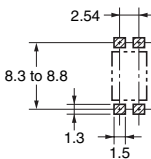


PCB Dimensions (BOTTOM VIEW)



Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)



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- Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
- Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

OMRON Corporation

ELECTRONIC AND MECHANICAL COMPONENTS COMPANY

Contact: www.omron.com/ecb

Cat. No. K260-E1-01
0913(0913)(O)

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